1. Description

- The M0019 is a limiter fabricated using a highly repetitive GaAs PIN MMIC process. The device operates from 7 to 13GHz, with an insertion loss of less than 0.8dB, input and output return loss of less than -12dB, a power handling capability of 47dBm (Pulse), and a flat leakage of 15dBm.

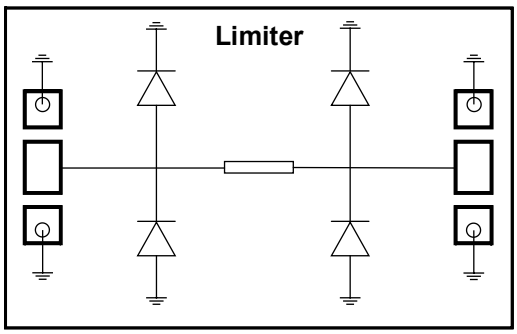


Figure 1. M0019 Functional Block Diagram

2. Applications

- Radio and Radar Receivers

3. Features[1]

- Operating Frequencies: 7-13GHz
- Insertion Loss: - 0.8dB
- Input/Output Return Loss: -12dB
- Power Handling Capability: 47dBm
- Flat Leakage: 15dBm
- Die Size: 1.45mm x 1.00mm x 0.10mm

[1] On-wafer Test

4. Brief Typical Performance

Table 1. Brief Typical Performance

Parameter	7-13GHz	Units
Insertion Loss	-0.8	dB
Input Return Loss	-12	dB
Output Return Loss	-12	dB
Power Handing Capability	47	dBm
Flat Leakage at P_{IN}>20dBm	15	dBm

Test condition: Input signal Pulsed, Pulse width = 100μs, Duty cycle = 25%

Table of Contents

No.	Contents	Page
1	Description	1
2	Applications	1
3	Features	1
4	Brief Typical Performance	1
5	Recommended Operating Conditions	3
6	RF Characteristics	3
7	Typical Performance Curve	3
8	Outline Dimension	4
9	Application Information	5
10	Handling Precautions	5
11	Disclaimer	6

5. Recommended Operating Conditions

Table 2. Recommended Operating Conditions

Parameter	Min.	Typ.	Max.	Units
Operating Temperature Range	-55	25	125	°C
Operating Frequency	7	-	13	GHz
Maximum Input Power	-	-	47	dBm

6. RF Characteristics (T_C = 25˚C)

Table 3. RF Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Units
Operating Frequencies	Freq	7	-	13	GHz
Insertion Loss	IL	-	-0.8	-	dB
Input Return Loss	RL_{IN}	-	-12	-	dB
Output Return Loss	RL_{OUT}	-	-12	-	dB
Power Handing Capability (Pulse)	Pc		47		dBm
Flat Leakage Power	FL	-	15	-	dBm

- Test condition: Input signal Pulsed, Pulse width = 100μs, Duty cycle = 25%

7. Typical Performance Curve

■ Small-signal Characteristics Curve

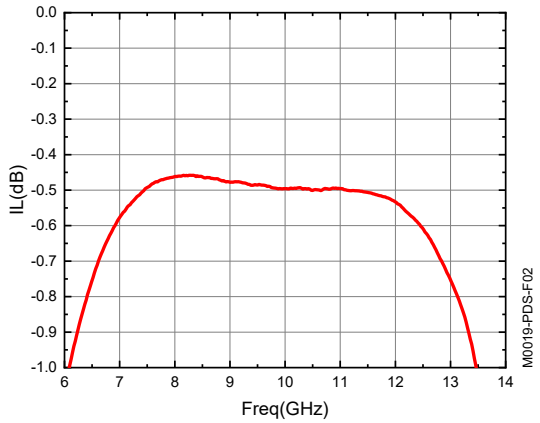


Figure 2. Insertion Loss Characteristics

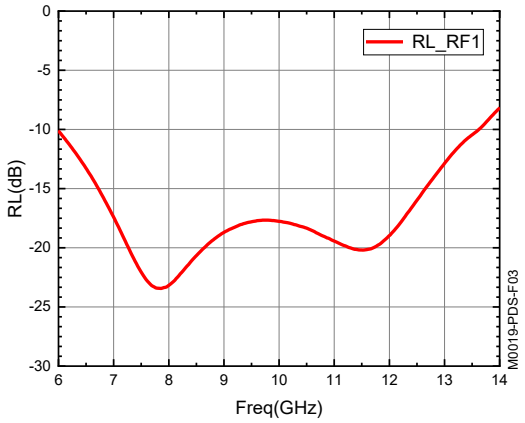


Figure 3. Input Return Loss Characteristics

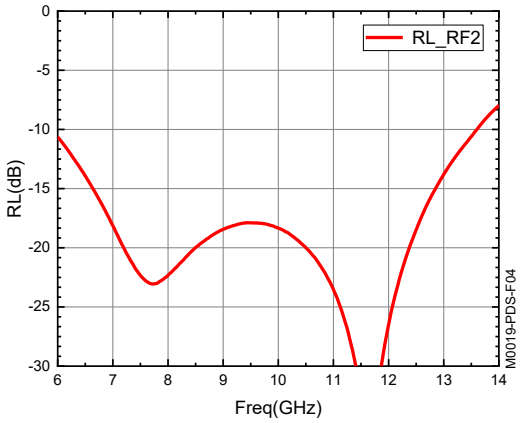


Figure 4. Output Return Loss Characteristics

■ Large-signal Characteristics Curve

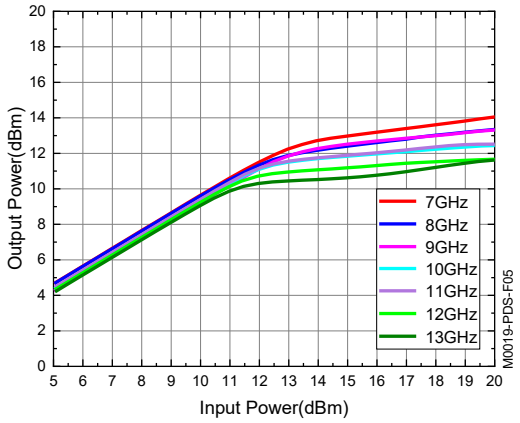


Figure 5. Large Signal Power Characteristics

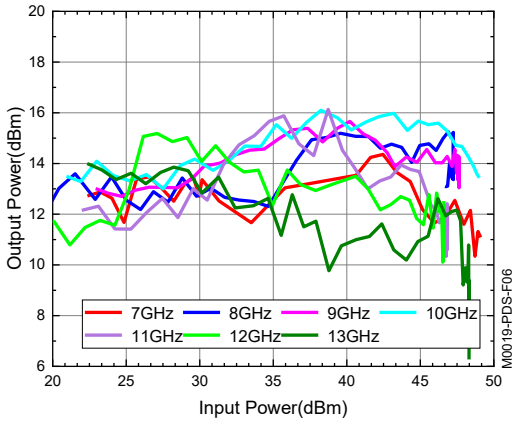
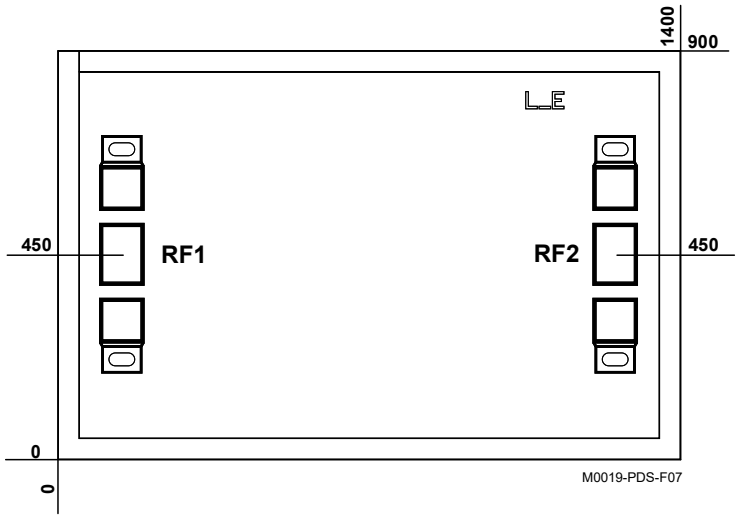


Figure 6. Flat Leakage Characteristics

8. Outline Dimensions



- Dimensions shown in micrometer

Figure 7. M0019 Bare Die

Table 4. Pin Description

Pin	Symbol	Description
1	RF1	RF Input
2	RF2	RF Output

9. Applications Information

■ Assembly Diagram

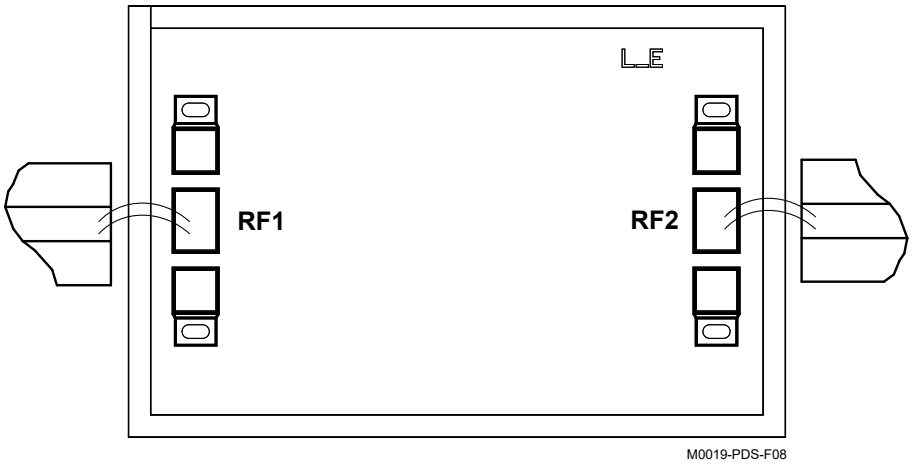


Figure 8. M0019 Application Assembly Diagram

- **Eutectic Die Attach:** It is best to use an 80% Au/20% Sn preform. Do not expose the chip to a temperature greater than 300°C for more than 30sec.
- **Wire Bonding:** RF bonds made with 1mil gold wire are recommended for the RF ports. Keep all bonds as short as possible, less than 0.35mm.

10. Handling Precautions

■ Storage

All bare dies ship in either Waffle or Gel Pak, which is an ESD protective container, and then sealed in an ESD protective bag. After opening the sealed ESD protective bag, all dies must be stored in a dry nitrogen environment.

■ Cleanliness

Handle the dies in a clean environment. Never use liquid cleaning systems to clean the dies.

■ ESD Caution

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore proper ESD precautions should be taken to avoid performance degradation or loss of functionality.



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